

PDM: Rev:B

STATUS: Released

Printed: Sep 28, 2007

(4X) 1.27 TYP .70 -SEE DETAIL "A" FOR PIN OUT #2.3 ±0.1 5.08 (2X) 41.91 64.50 (2X) 3.47 (2X) GROUNDING PAD 5.0 (2X) ø2.3 ±0.1 (2X) 7.0 — (2X) 59.00±0.05

1 | 2

SHIELD ROW (16X) PIN 1 PIN 2 PIN 67 PIN 35 PIN 36 PIN 68 DETAIL "A"

3 |

P.C.B. LAYOUT

## NOTES:

- (1) RECOMMENDED DIAMETER IS \$1.0. FOR PROCESSES USING PASTE REFLOW, HOLE MAY BE AS SMALL AS \$0.79.
- 2 ALL TOLERANCES ±0.15 UNLESS NOTED.

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					angle	es 0° ±2°			<b>Ψ Ψ</b>			L	DECK ASSEMBLY				<u>_Y</u>					
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form no. 7530-001-103

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